



REV.	ECN NO OR DESCRIPTION	REVISED	DATE

A

B

C

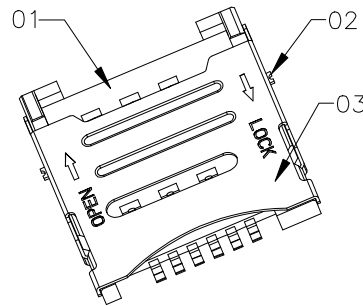
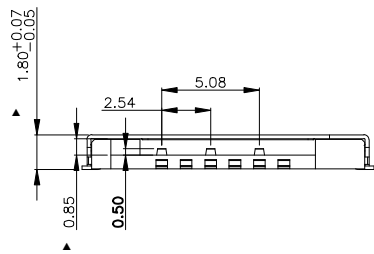
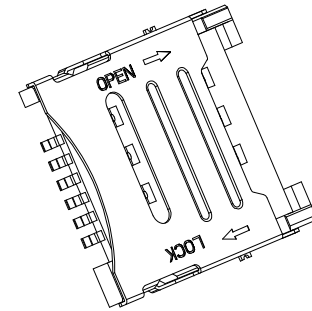
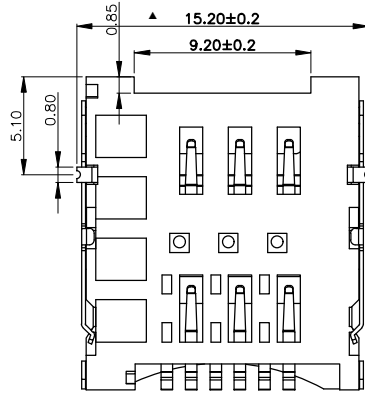
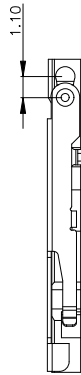
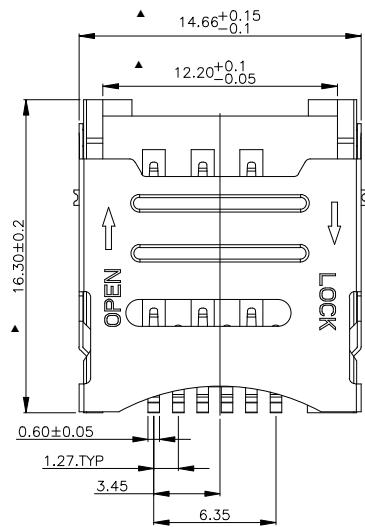
D

A

B

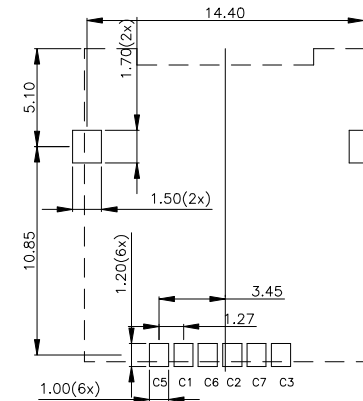
C

D



Connector Pin Assignment

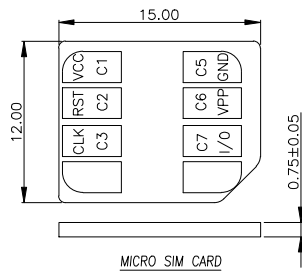
Pin Name	Description
C1	Vcc of SIM
C2	RST of SIM
C3	CLK of SIM
C5	GND of SIM
C6	Vpp of SIM
C7	I/O of SIM



▨ PCB 焊盘区

■ 下沉避位区

RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05



一、材质和镀法:

- 1、胶芯: LCP,UL 94V-0,黑色
- 2、端子: 磷铜C5210-H, T=0.15, 镍底镀金
- 3、外壳: 不锈钢SUS304 T=0.2

二、技术参数:

接触电阻: 100MΩ MAX
 绝缘阻抗: 1000MΩ MIN(500DC)
 额定电流: 每个接触件1A MAX
 额定电压: 30V MAX(DC)
 耐压: 500V R.M.S/MIN
 使用温度: -40℃~85℃
 湿度: 90%~95%
 寿命: >5000次

UNLESS OTHERWISE SPECIFIED TOLERANCES

DECIMALS:	ANGLES:
X :±0.5	X :±2°
X.X :±0.20	X.X :±1°
X.XX :±0.10	



东莞市汉博电子科技有限公司
DONGGUAN HANBO TECHNOLOGY CO., LTD

TITLE	6Pin H1.8 Hinged micro sim card conn.		
DWN	xiong	PART NO. SMO-1545	
CHKD	lee	SCALE:1:1	UNIT: mm
APVD	wang	SIZE: A4	SHEET:10F 1

CUSTOMER COPY